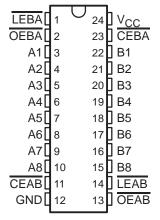
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- EPIC ™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 2 V at V_{CC} = 3.3 V, T_A = 25°C
- Power Off Disables Outputs, Permitting Live Insertion
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages

DB, DW, OR PW PACKAGE (TOP VIEW)



description

This octal registered transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC543A contains two sets of D-type latches for temporary storage of data flowing in either direction. Separate latch-enable (LEAB or LEBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) input must be low to enter data from A or to output data from B. If CEAB is low and LEAB is low, the A-to-B latches are transparent; a subsequent low-to-high transition of LEAB places the A latches in the storage mode. With CEAB and OEAB both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow for B to A is similar to that of A to B, but uses CEBA, LEBA, and OEBA.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

The SN74LVC543A is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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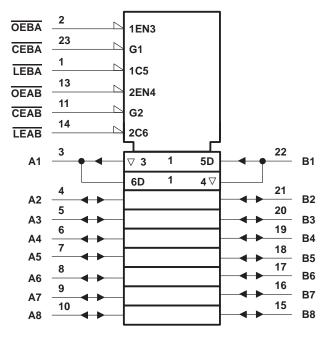
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FUNCTION TABLE†

	INPUTS								
CEAB	LEAB	OEAB	Α	В					
Н	Х	Х	Χ	Z					
Х	X	Н	Χ	Z					
L	Н	L	Χ	в ₀ ‡					
L	L	L	L	L					
L	L	L	Н	Н					

[†] A-to-B data flow is shown; B-to-A flow control is the same except that it uses CEBA, LEBA, and OEBA.

logic symbol§

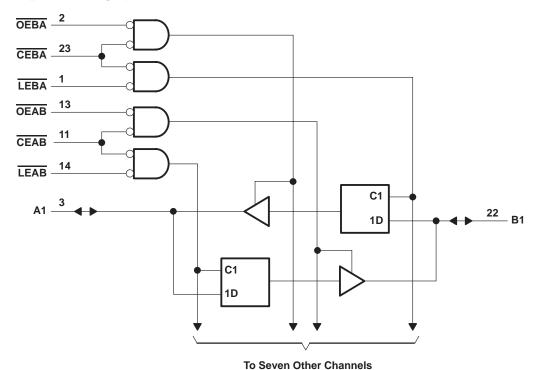


§ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



[‡]Output level before the indicated steady-state input conditions were established

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
Voltage range applied to any output in the high-impedance or power-off state, V _O	–0.5 V to 6.5 V
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Continuous output current, I _O	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3): DB package	104°C/W
DW package	81°C/W
PW package	120°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V_{CC} is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51.



SN74LVC543A **OCTAL REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS**

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recommended operating conditions (see Note 4)

			MIN	MAX	UNIT		
V	Supply voltage	Operating	1.65	3.6	V		
VCC	Supply voltage	Data retention only	1.5		V		
		V _{CC} = 1.65 V to 1.95 V	0.65×V _{CC}				
V_{IH}	/IH High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V		
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2				
		V _{CC} = 1.65 V to 1.95 V		0.35×V _{CC}			
V_{IL}	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V		
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8			
٧ _I	Input voltage		0	5.5	V		
.,	Output voltage	High or low state	0	Vcc	V		
VO		3 state	0	5.5	V		
		V _{CC} = 1.65 V		-4			
1	High lavel autout august	V _{CC} = 2.3 V		-8	A		
ЮН	High-level output current	V _{CC} = 2.7 V		-12	mA		
		V _{CC} = 3 V		-24			
I _{OL} Low-leve		V _{CC} = 1.65 V		4			
	Lave laved authors average	V _{CC} = 2.3 V		8	A		
	Low-level output current	V _{CC} = 2.7 V		12	mA		
		V _{CC} = 3 V		24			
Δt/Δν	Input transition rise or fall rate	•	0	10	ns/V		
TA	Operating free-air temperature		-40	85	°C		

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS		VCC	MIN	TYP†	MAX	UNIT	
		I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} -0.	.2				
		I _{OH} = -4 mA	1.65 V	1.2					
\ _{\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\}		I _{OH} = -8 mA		2.3 V	1.7			V	
VOH		I _{OH} = -12 mA		2.7 V	2.2			V	
		IOH = -12 IIIA		3 V	2.4				
		I _{OH} = -24 mA		3 V	2.2				
		I _{OL} = 100 μA		1.65 V to 3.6 V			0.2		
		I _{OL} = 4 mA	1.65 V			0.45	V		
VOL		I _{OL} = 8 mA	2.3 V			0.7			
		I _{OL} = 12 mA	2.7 V			0.4			
		I _{OL} = 24 mA		3 V			0.55		
Ц	Control inputs	V _I = 0 to 5.5 V		3.6 V			±5	μΑ	
l _{off}		V_I or $V_O = 5.5 V$		0			±10	μΑ	
loz‡		V _O = 0 to 5.5 V		3.6 V			±10	μΑ	
1		V _I = V _{CC} or GND	1- 0	261/			10	^	
ICC		3.6 V ≤ V _I ≤ 5.5 V§	IO = 0	3.6 V			10	μΑ	
Δlcc	ΔI_{CC} One input at $V_{CC} - 0.6 \text{ V}$, Other inputs at V_{CC} or GND		at V _{CC} or GND	2.7 V to 3.6 V			500	μΑ	
Ci	Control inputs	V _I = V _{CC} or GND		3.3 V		4.5		pF	
C _{io}	A or B ports	$V_O = V_{CC}$ or GND		3.3 V		7.5		pF	

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

		V _{CC} =		V _{CC} =	2.5 V 2 V	VCC =	2.7 V	V _{CC} = ± 0.3	3.3 V 3 V	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _W	Pulse duration	¶		¶		3.3		3.3		ns
t _{su}	Setup time, data before LE↑ or CE↑	¶		¶		1.6		1.6		ns
t _h	Hold time, data after LE↑ or CE↑	1		¶		2.1		2.1		ns

This information was not available at the time of publication.

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. ‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.

[§] This applies in the disabled state only.

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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} =	1.8 V 5 V	V _{CC} =	2.5 V 2 V	VCC =	2.7 V	V _{CC} =	3.3 V 3 V	UNIT
	(INFOT)	(001701)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
+ .	A or B	B or A	†	†	†	†		8	1	7	ns
^t pd	LE	BUIA	†	†	†	†		9.5	1.2	8.5	115
	ŌĒ	A or B	†	†	†	†		9.2	1.3	7.7	no
^t en	CE		†	†	†	†		9.3	1.3	8	ns
^t dis	ŌĒ	A == D	†	†	†	†		7.5	1	7	no
	CE	A or B	†	†	†	†		7.5	1	7	ns

[†] This information was not available at the time of publication.

operating characteristics, $T_A = 25^{\circ}C$

PARAMETER			TEST CONDITIONS	V _{CC} = 1.8 V ± 0.15 V	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V	UNIT
		CONDITIONS	TYP	TYP	TYP		
C _{pd}	Power dissipation capacitance	Outputs enabled	f = 10 MHz	†	†	49	pF
Opa	per transceiver	Outputs disabled	I = IU MIHZ	†	†	6	h.

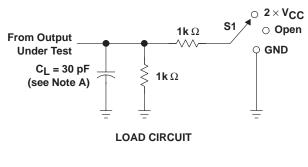
[†] This information was not available at the time of publication.



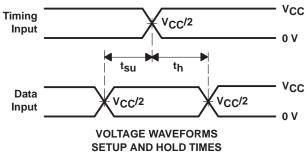
VCC

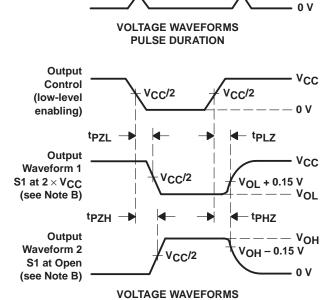
V_{CC}/2

PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$



TEST	S1
t _{pd}	Open
tPLZ/tPZL	2×V _{CC}
tPHZ/tPZH	Open

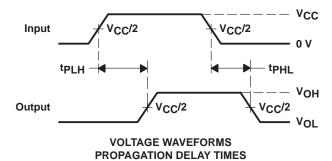




ENABLE AND DISABLE TIMES

V_{CC}/2

Input

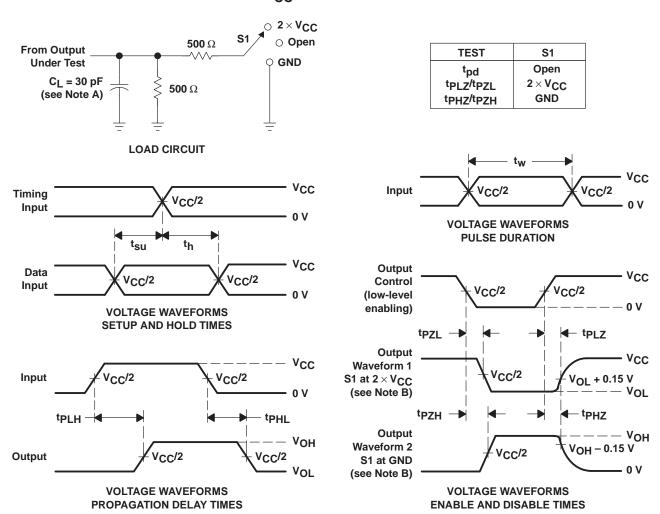


NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \ \Omega$, $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$



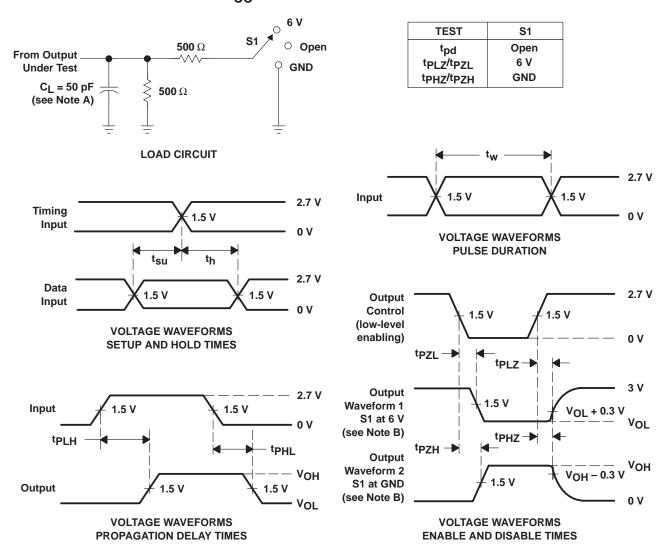
NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z $_{O}$ = 50 Ω , $t_{f} \leq$ 2 ns, $t_{f} \leq$ 2 ns, $t_{f} \leq$ 2 ns, $t_{f} \leq$ 10 mHz, Z $_{O}$ = 50 Ω , $t_{f} \leq$ 10 mHz, Z $_{O}$
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzl and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION V_{CC} = 2.7 V AND 3.3 V \pm 0.3 V



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis-
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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